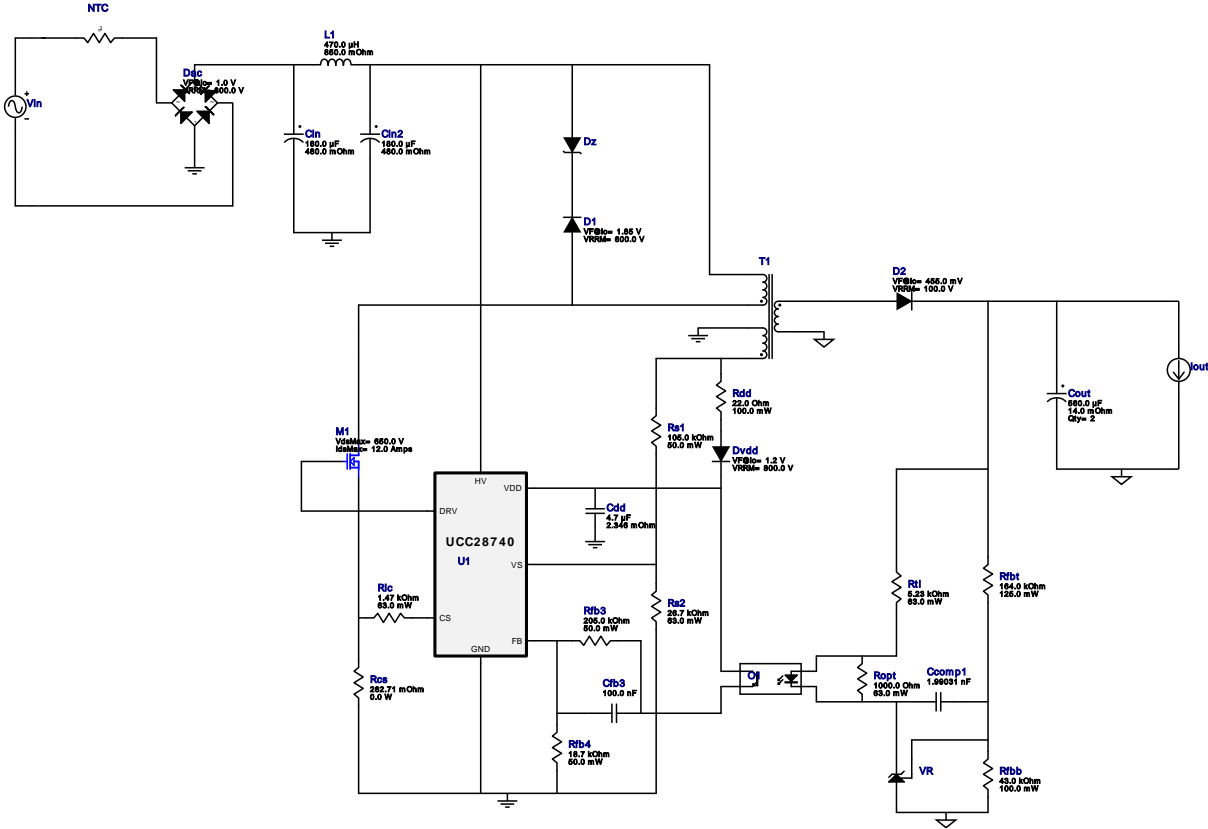


VinMin = 90.0V  
 VinMax = 265.0V  
 Vout = 12.0V  
 Iout = 5.0A

Device = UCC28740DR  
 Topology = Flyback  
 Created = 2022-02-18 00:08:09.373  
 BOM Cost = NA  
 BOM Count = 30  
 Total Pd = 17.16W

# WEBENCH® Design Report

Design : 32 UCC28740DR  
 UCC28740DR 90V-265V to 12.00V @ 5A



1. Rlc, Rtl and the feedback resistors for this design are a starting point, but may need adjustment based on the actual transformer used. For more information please click the design assistance button.
2. Click on the transformer symbol and select 'Design Transformer' to design using specific transformer cores and bobbin

## Design Alerts

### Component Selection Information

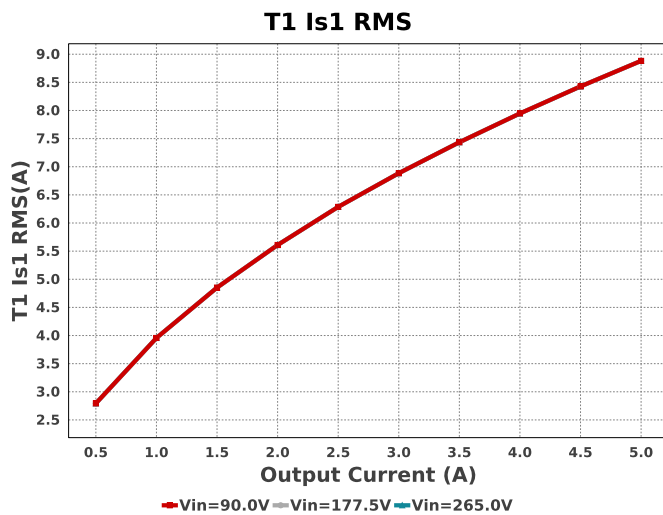
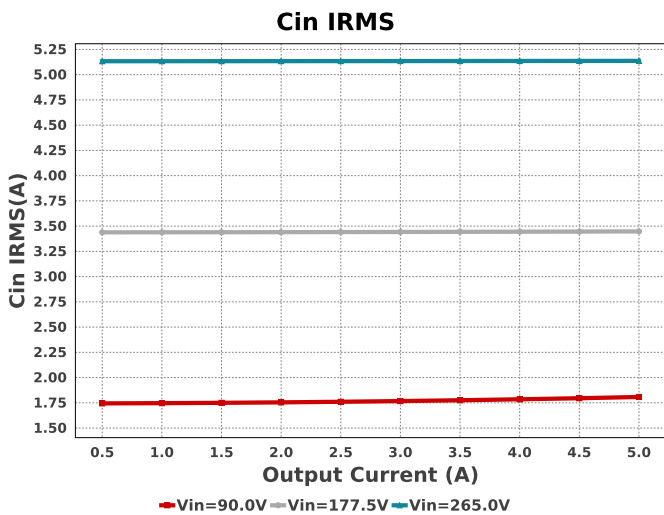
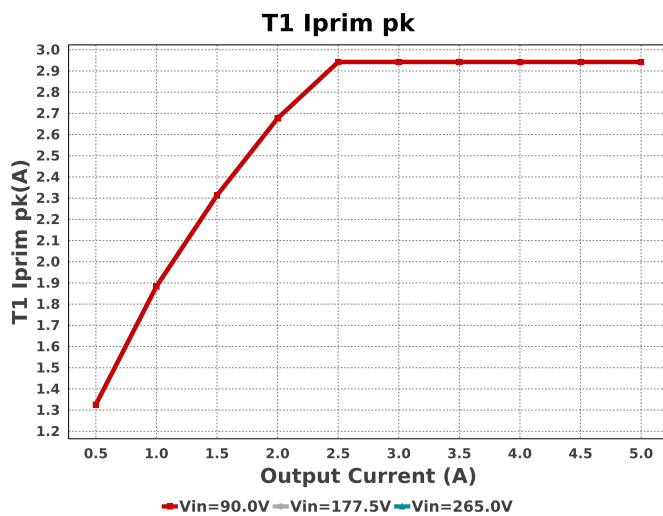
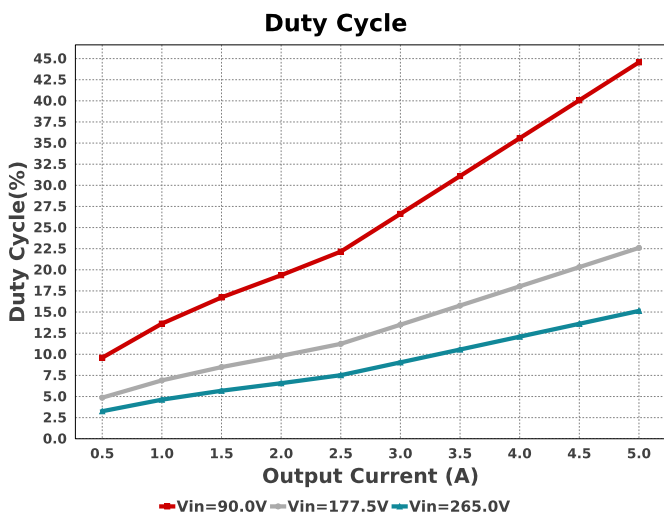
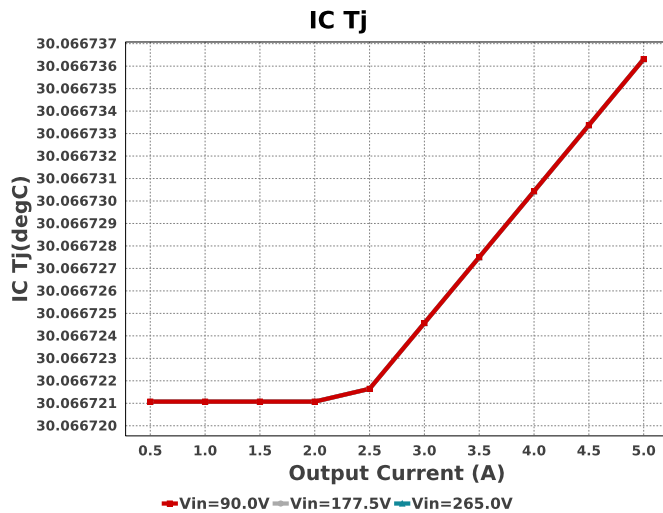
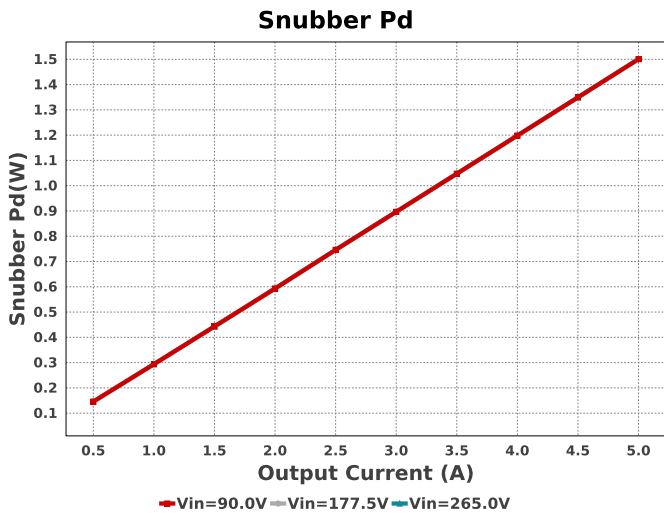
Click on the transformer symbol in the schematic and select "Explore Transformer Core/Bobbin Selection" to design using specific transformer cores and bobbin.

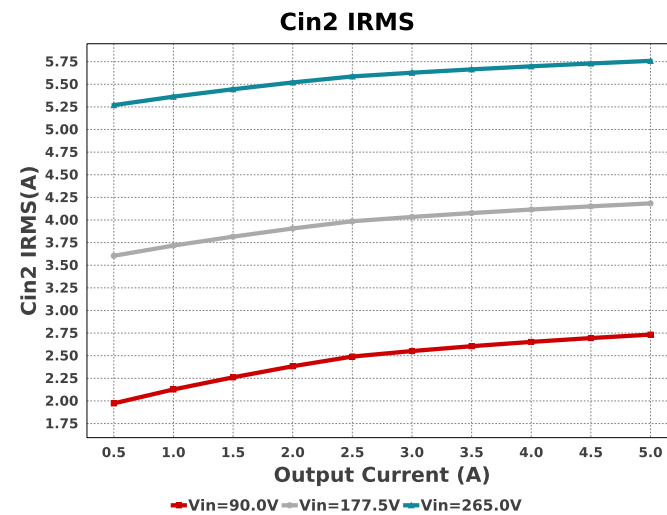
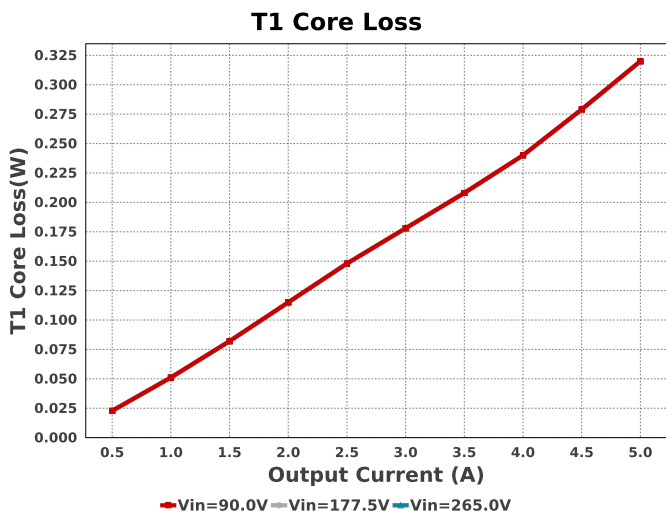
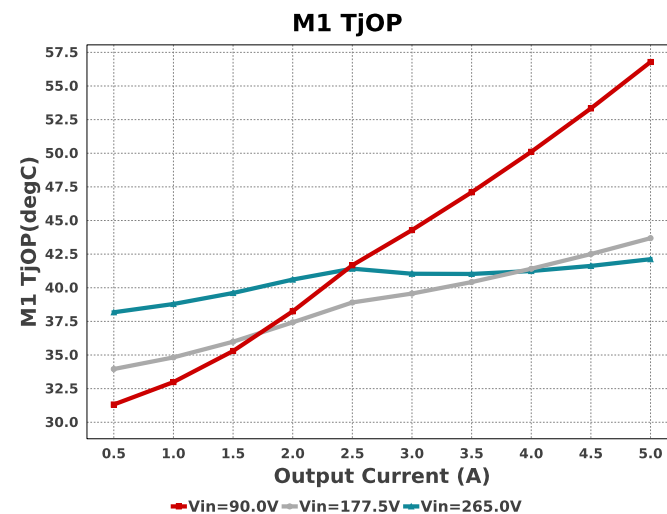
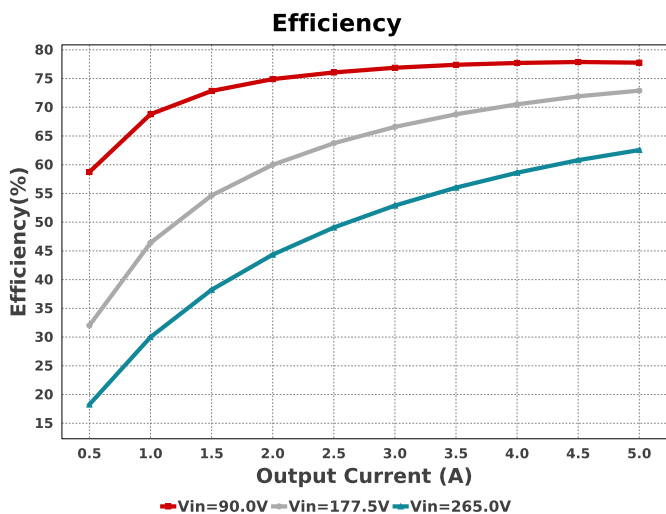
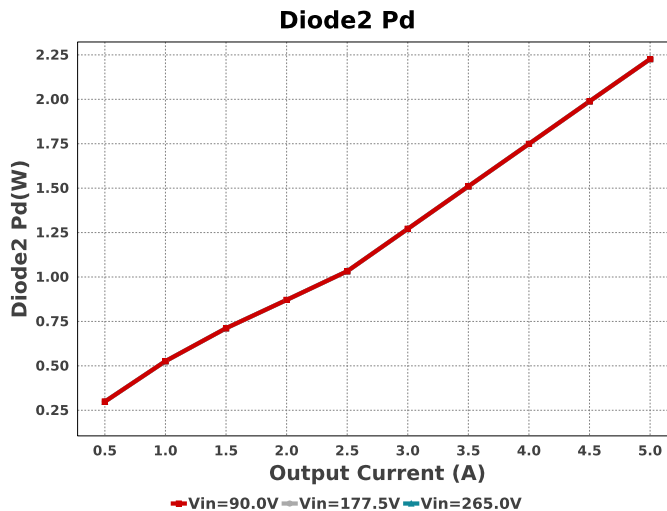
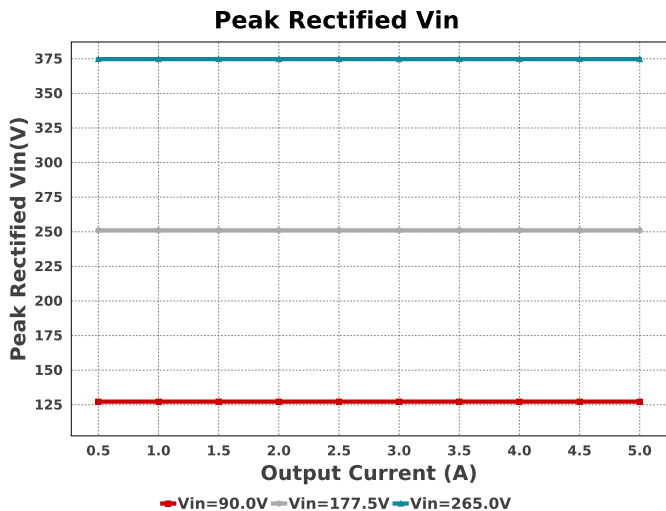
## Electrical BOM

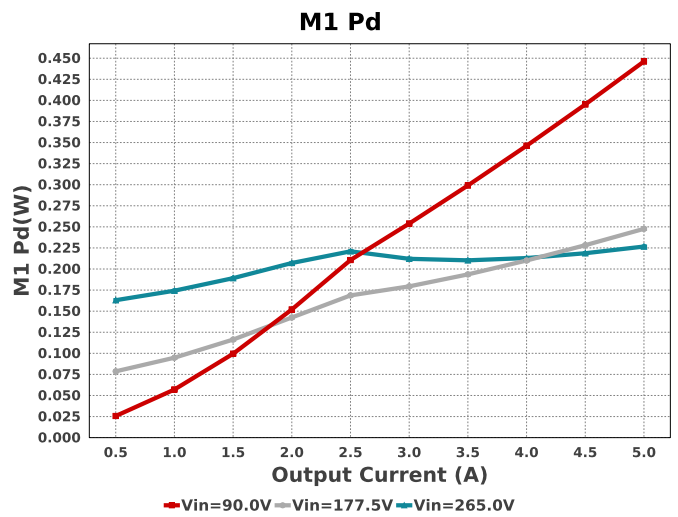
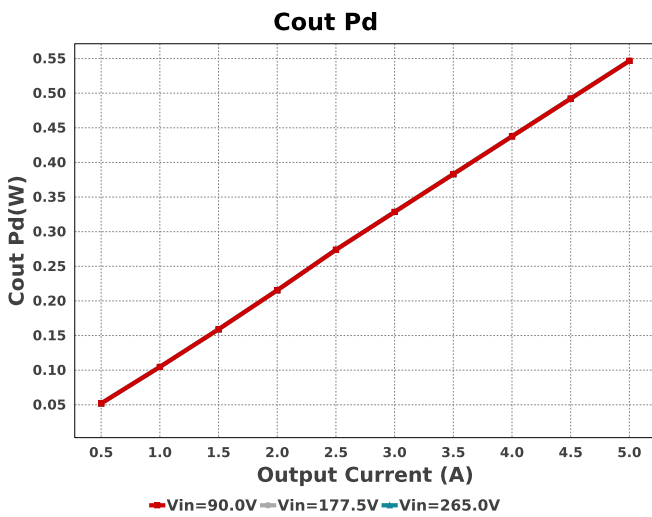
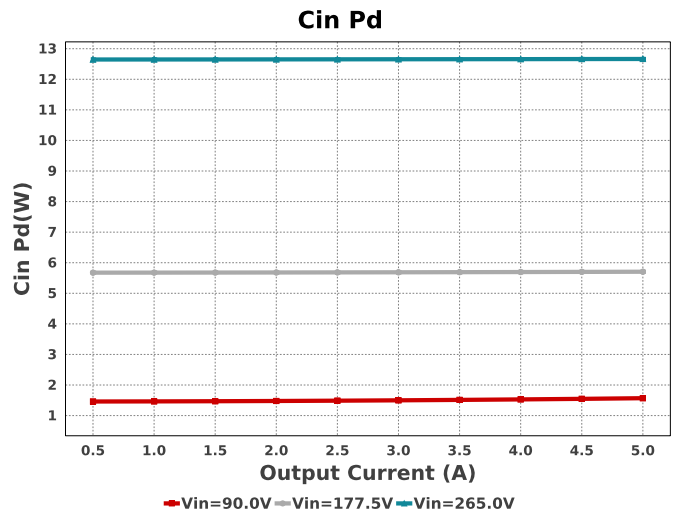
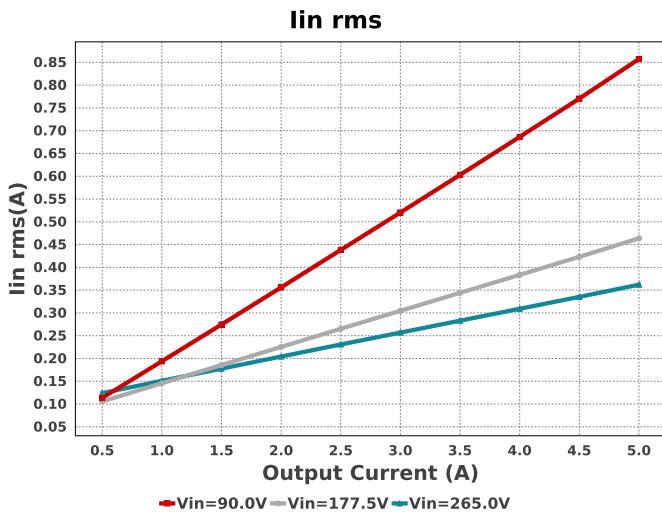
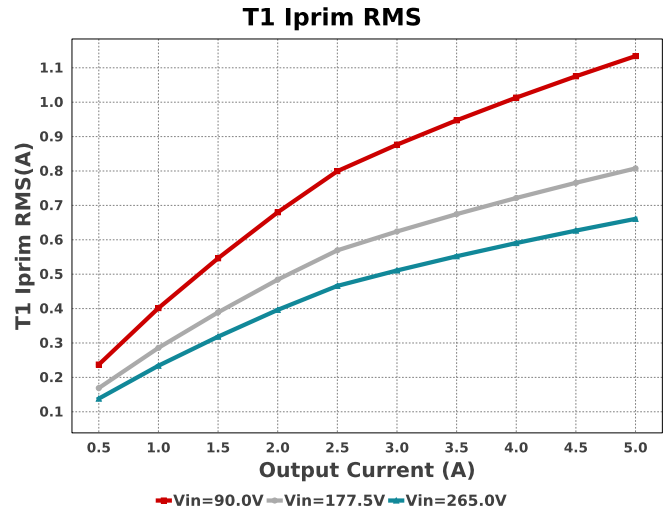
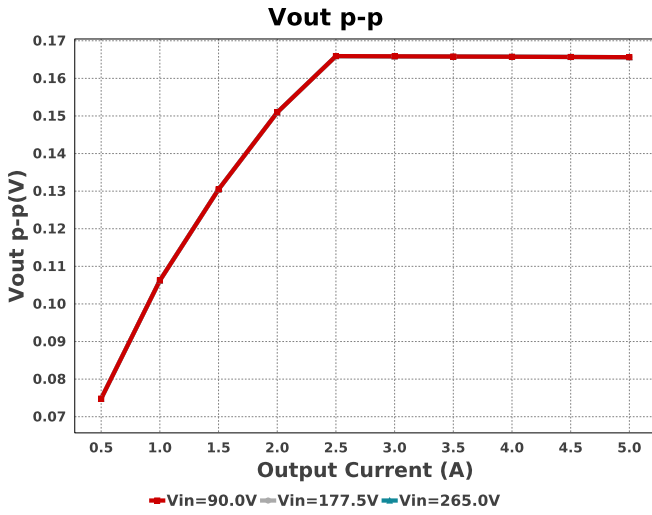
Name	Manufacturer	Part Number	Properties	Qty	Price	Footprint
Ccomp1	CUSTOM	CUSTOM Series= ?	Cap= 1.99031 nF VDC= 0.0 V IRMS= 0.0 A	1	NA	CUSTOM 0 mm <sup>2</sup>
Cdd	TDK	C2012X7R1V475K125AC Series= X7R	Cap= 4.7 uF ESR= 2.346 mOhm VDC= 35.0 V IRMS= 4.2602 A	1	\$0.18	0805 7 mm <sup>2</sup>
Cfb3	AVX	08053C104JAZ2A Series= X7R	Cap= 100.0 nF VDC= 25.0 V IRMS= 0.0 A	1	\$0.06	0805 7 mm <sup>2</sup>

Name	Manufacturer	Part Number	Properties	Qty	Price	Footprint
Cin	Vishay-Bccomponents	MAL215959181E3 Series= 2378	Cap= 180.0 uF ESR= 480.0 mOhm VDC= 500.0 V IRMS= 1.13 A	1	\$5.30	 159PUL-SI_3000x3500 1024 mm <sup>2</sup>
Cin2	Vishay-Bccomponents	MAL215959181E3 Series= 2378	Cap= 180.0 uF ESR= 480.0 mOhm VDC= 500.0 V IRMS= 1.13 A	1	\$5.30	 159PUL-SI_3000x3500 1024 mm <sup>2</sup>
Cout	Panasonic	16SVPF560M Series= SVPF	Cap= 560.0 uF ESR= 14.0 mOhm VDC= 16.0 V IRMS= 4.95 A	2	\$0.63	 CAPSMT_62_E12 106 mm <sup>2</sup>
D1	STMicroelectronics	STTH506B-TR	VF@Io= 1.85 V VRRM= 600.0 V	1	\$0.63	 DPAK 102 mm <sup>2</sup>
D2	STMicroelectronics	STPS20M100SG-TR	VF@Io= 455.0 mV VRRM= 100.0 V	1	\$1.33	 DDPAK 210 mm <sup>2</sup>
Dac	Vishay-Semiconductor	GBU4K-E3/45	VF@Io= 1.0 V VRRM= 800.0 V	1	\$0.68	 GBU 131 mm <sup>2</sup>
Dvdd	Microsemi	UFS180JE3/TR13	VF@Io= 1.2 V VRRM= 800.0 V	1	\$0.73	 DO-214BA 42 mm <sup>2</sup>
Dz	Diodes Inc.	SMBJ120A-13-F	Zener	1	\$0.09	 SMB 44 mm <sup>2</sup>
L1	NIC Components	NPI52W471MTRF	L= 470.0 uH 850.0 mOhm	1	\$0.35	 IND_NPI52W 358 mm <sup>2</sup>
M1	STMicroelectronics	STD16N65M5	VdsMax= 650.0 V IdsMax= 12.0 Amps	1	\$2.03	 DPAK 102 mm <sup>2</sup>

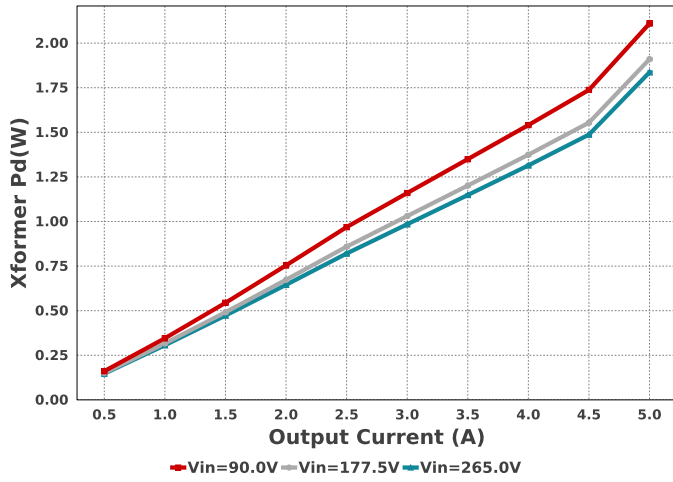
Name	Manufacturer	Part Number	Properties	Qty	Price	Footprint
NTC	GE Sensing	CL-40 Series= CL	Thermistor	1	\$0.72	 Thermistor_CL-40 164 mm <sup>2</sup>
O1	California Eastern Laboratories	PS2811-1	Optocoupler	1	\$0.46	 SSOP-4 111 mm <sup>2</sup>
Rcs	CUSTOM	CUSTOM Series= ?	Res= 262.71 mOhm Power= 0.0 W Tolerance= 0.0%	1	NA	CUSTOM 0 mm <sup>2</sup>
Rdd	Yageo	RC0603FR-0722RL Series= ?	Res= 22.0 Ohm Power= 100.0 mW Tolerance= 1.0%	1	\$0.01	 0603 5 mm <sup>2</sup>
Rfb3	Yageo	RC0201FR-07205KL Series= ?	Res= 205.0 kOhm Power= 50.0 mW Tolerance= 1.0%	1	\$0.01	 0201 2 mm <sup>2</sup>
Rfb4	Yageo	RC0201FR-0718K7L Series= ?	Res= 18.7 kOhm Power= 50.0 mW Tolerance= 1.0%	1	\$0.01	 0201 2 mm <sup>2</sup>
Rfbb	Yageo	RC0603FR-0743KL Series= ?	Res= 43.0 kOhm Power= 100.0 mW Tolerance= 1.0%	1	\$0.01	 0603 5 mm <sup>2</sup>
Rfbt	Yageo	RT0805BRD07164KL Series= RT0805	Res= 164.0 kOhm Power= 125.0 mW Tolerance= 0.1%	1	\$0.06	 0805 7 mm <sup>2</sup>
Rlc	Vishay-Dale	CRCW04021K47FKED Series= CRCW..e3	Res= 1.47 kOhm Power= 63.0 mW Tolerance= 1.0%	1	\$0.01	 0402 3 mm <sup>2</sup>
Ropt	Vishay-Dale	CRCW04021K00FKED Series= CRCW..e3	Res= 1000.0 Ohm Power= 63.0 mW Tolerance= 1.0%	1	\$0.01	 0402 3 mm <sup>2</sup>
Rs1	Yageo	RC0201FR-07105KL Series= ?	Res= 105.0 kOhm Power= 50.0 mW Tolerance= 1.0%	1	\$0.01	 0201 2 mm <sup>2</sup>
Rs2	Vishay-Dale	CRCW040226K7FKED Series= CRCW..e3	Res= 26.7 kOhm Power= 63.0 mW Tolerance= 1.0%	1	\$0.01	 0402 3 mm <sup>2</sup>
Rtl	Vishay-Dale	CRCW04025K23FKED Series= CRCW..e3	Res= 5.23 kOhm Power= 63.0 mW Tolerance= 1.0%	1	\$0.01	 0402 3 mm <sup>2</sup>
T1	Core=TDK , CoilFormer=TDK	Core=B66421G0000X197 , CoilFormer=B66422W1010D001	Lp= 259.0 µH Turns Ratio(Nas)= 11:7 Turns Ratio(Nps)= 58:7 Npri= 58.0 Naux= 11.0 Nsec= 7.0	1	\$0.35	 TDK_B66305 756 mm <sup>2</sup>
U1	Texas Instruments	UCC28740DR	Switcher	1	\$0.38	 R-PDSO-G7 55 mm <sup>2</sup>
VR	Texas Instruments	TL431IDBVR	Voltage References	1	\$0.07	 R-PDSO-G3 16 mm <sup>2</sup>



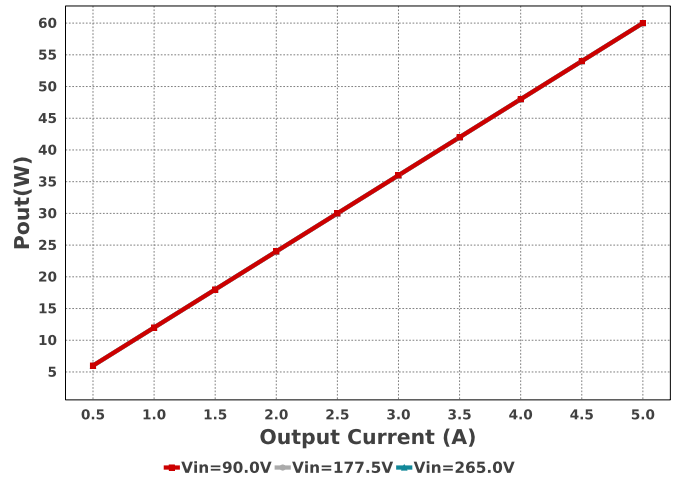




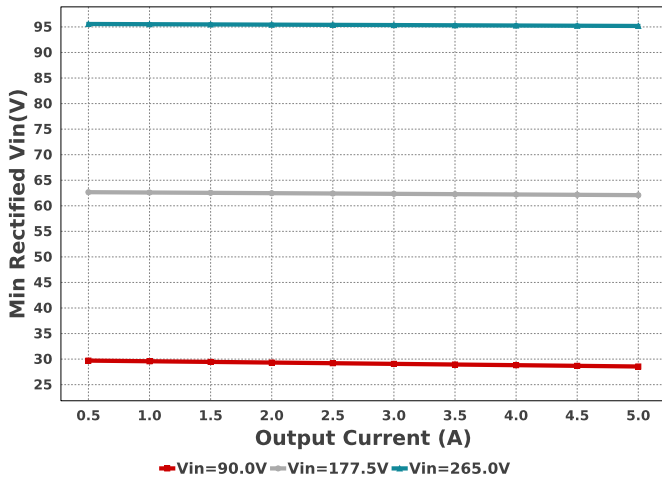
**Xformer Pd**



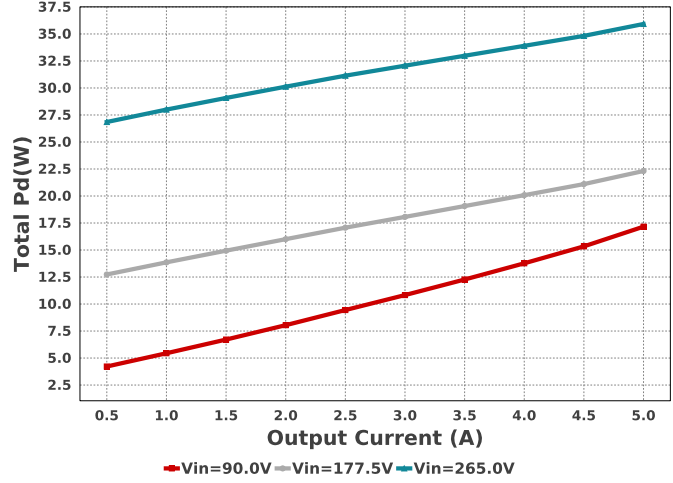
**Pout**



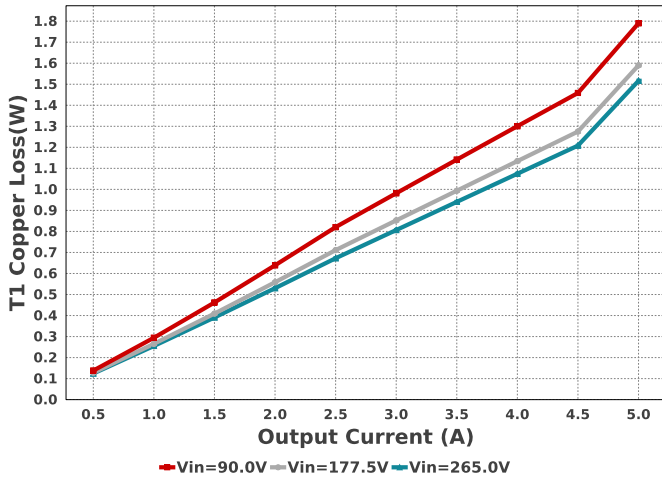
**Min Rectified Vin**



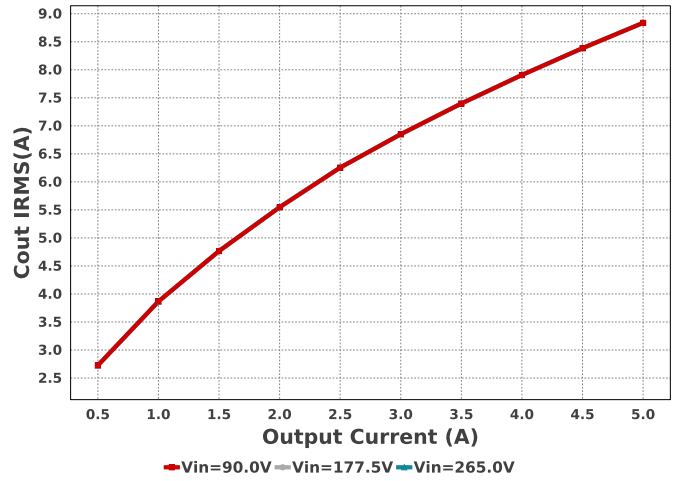
**Total Pd**

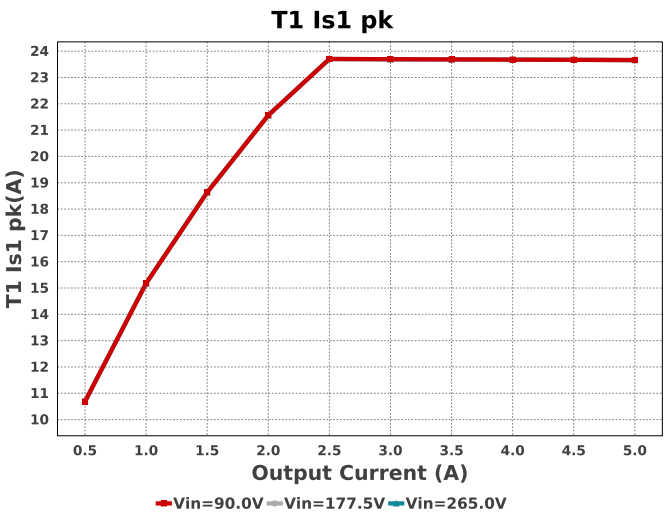
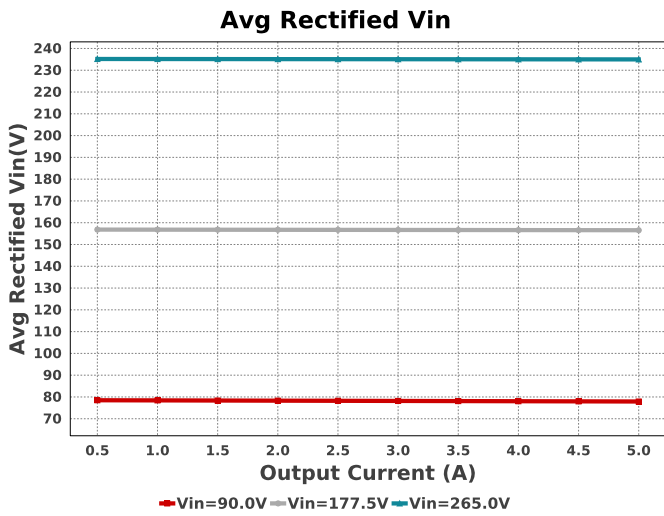
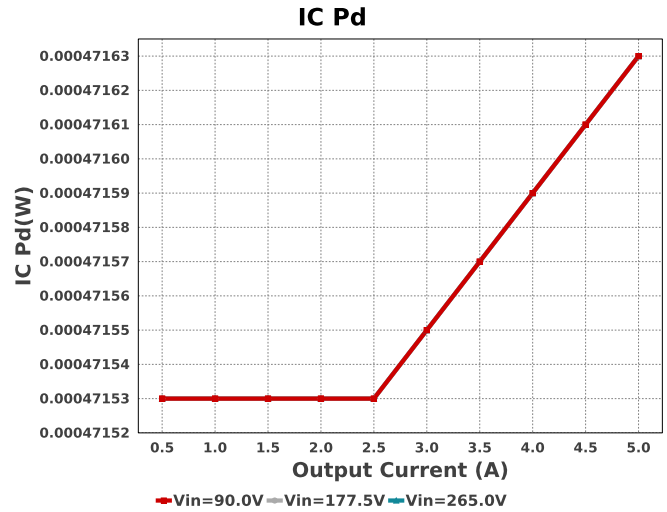
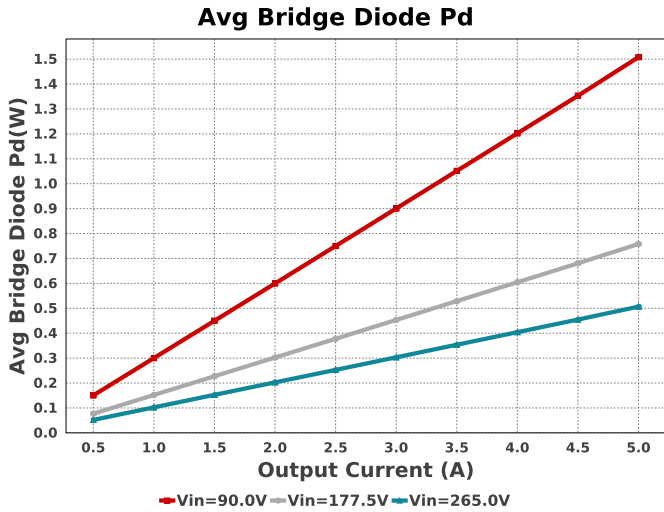


**T1 Copper Loss**



**Cout IRMS**





Operating Values

#	Name	Value	Category	Description
1.	Cin IRMS	1.808 A	Capacitor	Input capacitor RMS ripple current
2.	Cin Pd	1.568 W	Capacitor	Input capacitor power dissipation
3.	Cin2 IRMS	2.733 A	Capacitor	Input Capacitor Cin2 RMS Ripple Current
4.	Cout IRMS	8.837 A	Capacitor	Output capacitor RMS ripple current
5.	Cout Pd	546.66 mW	Capacitor	Output capacitor power dissipation
6.	Avg Bridge Diode Pd	1.506 W	Diode	Average Power Dissipation in the Bridge Diode over the AC Line Period
7.	Diode2 Pd	2.226 W	Diode	Diode2 power dissipation
8.	IC Pd	471.63 μW	IC	IC power dissipation
9.	IC Tj	30.067 degC	IC	IC junction temperature
10.	ICThetaJA	141.5 degC/W	IC	IC junction-to-ambient thermal resistance
11.	M1 Pd	446.16 mW	Mosfet	M1 MOSFET total power dissipation
12.	M1 TjOP	56.785 degC	Mosfet	M1 MOSFET junction temperature
13.	Avg Bridge Diode Pd	1.508 W	Power	Average Power Dissipation in the Bridge Diode over the AC Line Period
14.	Cin Pd	1.569 W	Power	Input capacitor power dissipation
15.	Cout Pd	546.66 mW	Power	Output capacitor power dissipation
16.	Diode2 Pd	2.226 W	Power	Diode2 power dissipation
17.	IC Pd	471.63 μW	Power	IC power dissipation
18.	M1 Pd	446.15 mW	Power	M1 MOSFET total power dissipation
19.	Snubber Pd	1.501 W	Power	Snubber Power Dissipation
20.	T1 Copper Loss	1.79 W	Power	Transformer Copper Loss Power Dissipation
21.	T1 Core Loss	320.0 mW	Power	Transformer Core Loss Power Dissipation
22.	Total Pd	17.162 W	Power	Total Power Dissipation
23.	Xformer Pd	2.11 W	Power	Transformer power dissipation
24.	Avg Rectified Vin	77.915 V	System	Average Rectified Voltage for the AC Line Period
25.	BOM Count	30	System	Total Design BOM count
26.	Duty Cycle	44.561 %	System	Duty cycle
27.	Efficiency	77.758 %	System	Steady state efficiency



#	Name	Value	Category	Description
28.	FootPrint	4.408 k mm <sup>2</sup>	System Information	Total Foot Print Area of BOM components
29.	Frequency	67.006 kHz	System Information	Switching frequency
30.	Frequency	67.005 kHz	System Information	Switching frequency
31.	Iin rms	857.36 mA	System Information	RMS Input Current
32.	Iout	5.0 A	System Information	Iout operating point
33.	Min Rectified Vin	28.551 V	System Information	Minimum voltage seen at rectified input
34.	Mode	DCM	System Information	Conduction Mode
35.	Peak Rectified Vin	127.278 V	System Information	Peak voltage seen at rectified input
36.	Pout	60.0 W	System Information	Total output power
37.	Total BOM	NA	System Information	Total BOM Cost
38.	Vin_RMS	90.0 V	System Information	Vin operating point
39.	Vout	12.0 V	System Information	Operational Output Voltage
40.	Vout Actual	12.035 V	System Information	Vout Actual calculated based on selected voltage divider resistors
41.	Vout Tolerance	1.203 %	System Information	Vout Tolerance based on IC Tolerance (no load) and voltage divider resistors if applicable
42.	Vout p-p	165.633 mV	System Information	Peak-to-peak output ripple voltage
43.	T1 Copper Loss	1.729 W	Transformer	Transformer Copper Loss Power Dissipation
44.	T1 Core Loss	293.0 mW	Transformer	Transformer Core Loss Power Dissipation
45.	T1 Iprim RMS	1.134 A	Transformer	Transformer Primary RMS Current
46.	T1 Iprim pk	2.942 A	Transformer	Transformer Primary Peak Current
47.	T1 Is1 RMS	8.882 A	Transformer	Transformer Secondary1 RMS Current
48.	T1 Is1 pk	23.662 A	Transformer	Transformer Secondary1 Peak Current
49.	Xformer Pd	2.022 W	Transformer	Transformer power dissipation

## Design Inputs

Name	Value	Description
Iout	5.0	Maximum Output Current
VinMax	265.0	Maximum input voltage
VinMin	90.0	Minimum input voltage
Vout	12.0	Output Voltage
acFrequency	60.0	AC Frequency
base_pn	UCC28740	Base Product Number
source	DC	Input Source Type
Ta	30.0	Ambient temperature

## WEBENCH® Assembly

### Component Testing

Some published data on components in datasheets such as Capacitor ESR and Inductor DC resistance is based on conservative values that will guarantee that the components always exceed the specification. For design purposes it is usually better to work with typical values. Since this data is not always available it is a good practice to measure the Capacitance and ESR values of  $C_{in}$  and  $C_{out}$ , and the inductance and DC resistance of L1 before assembly of the board. Any large discrepancies in values should be electrically simulated in WEBENCH to check for instabilities and thermally simulated in WebTHERM to make sure critical temperatures are not exceeded.

### Soldering Component to Board

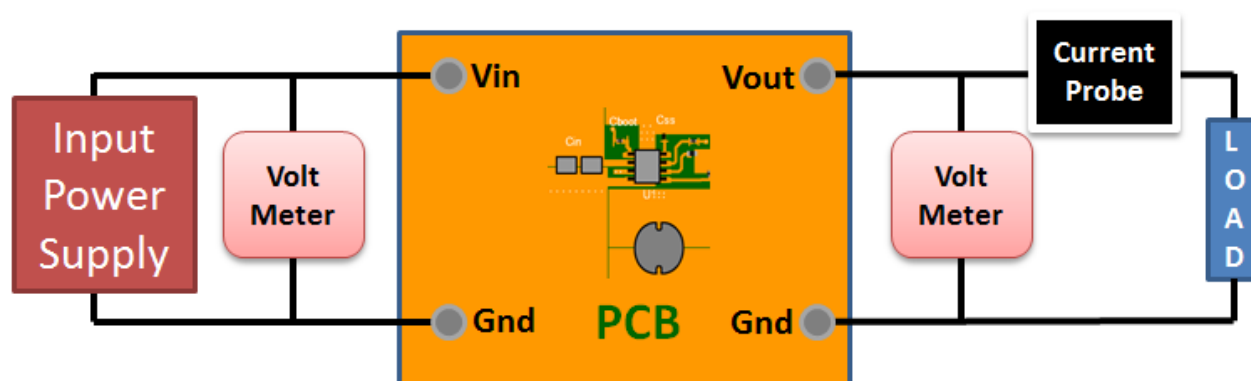
If board assembly is done in house it is best to tack down one terminal of a component on the board then solder the other terminal. For surface mount parts with large tabs, such as the DPAK, the tab on the back of the package should be pre-tinned with solder, then tacked into place by one of the pins. To solder the tab down to the board place the iron down on the board while resting against the tab, heating both surfaces simultaneously. Apply light pressure to the top of the plastic case until the solder flows around the part and the part is flush with the PCB. If the solder is not flowing around the board you may need a higher wattage iron (generally 25W to 30W is enough).

### Initial Startup of Circuit

It is best to initially power up the board by setting the input supply voltage to the lowest operating input voltage 90.0V and set the input supply's current limit to zero. With the input supply off connect up the input supply to  $V_{in}$  and GND. Connect a digital volt meter and a load if needed to set the minimum load of the design from  $V_{out}$  and GND. Turn on the input supply and slowly turn up the current limit on the input supply. If the voltage starts to rise on the input supply continue increasing the input supply current limit while watching the output voltage. If the current increases on the input supply, but the voltage remains near zero, then there may be a short or a component misplaced on the board. Power down the board and visually inspect for solder bridges and recheck the diode and capacitor polarities. Once the power supply circuit is operational then more extensive testing may include full load testing, transient load and line tests to compare with simulation results.

### Load Testing

The setup is the same as the initial startup, except that an additional digital voltmeter is connected between  $V_{in}$  and GND, a load is connected between  $V_{out}$  and GND and a current meter is connected in series between  $V_{out}$  and the load. The load must be able to handle at least rated output power + 50% ( 7.5 watts for this design). Ideally the load is supplied in the form of a variable load test unit. It can also be done in the form of suitably large power resistors. When using an oscilloscope to measure waveforms on the prototype board, the ground leads of the oscilloscope probes should be as short as possible and the area of the loop formed by the ground lead should be kept to a minimum. This will help reduce ground lead inductance and eliminate EMI noise that is not actually present in the circuit.



## WEBENCH® Transformer Report

#	Name	Value
1.	Core Part Number	B66421G0000X197
2.	Core Manufacturer	TDK
3.	Coil Former Part Number	B66422W1010D001
4.	Coil Former Manufacturer	TDK

### Transformer Electrical Diagram

#### Primary

Turns	58.0
AWG	29.0
Layers	4.0
Strands	3.0
Insulation Type	Heavy Insulated Magnet Wire

#### Secondary

Turns	7.0
AWG	26.0
Layers	1.0
Strands	3.0
Insulation Type	Triple Insulated

#### Auxiliary

Turns	11.0
AWG	28.0
Layers	1.0
Strands	4.0
Insulation Type	Heavy Insulated Magnet Wire

### Transformer Construction Diagram

#### Winding Instruction

Winding	AWG	Turns	Winding Orientation
Primary First 2/4.0	29.0	29	Clockwise
Auxiliary	28.0	11.0	Counter Clockwise
Triple Insulated Secondary	26.0	7.0	Counter Clockwise
Primary Second 2/4.0	29.0	29	Clockwise

#### Transformer Parameters

#	Name	Value
1.	Lpri	2.59E-4H
2.	Inductance Factor(AI)	77.0nH
3.	Npri	58.0
4.	Nsec	7.0
5.	Naux	11.0
6.	Core Type	EFD25/13/9
7.	Core Material	N97

#	Name	Value
8.	Bmax	0.23T
9.	Switching Frequency	63.00kHz
10.	DMax	0.51
11.	Ipk(Primary)	2.94A
12.	Irms(Primary)	1.22A
13.	Ipk(Secondary)	24.4A
14.	Irms(Secondary)	9.18A

## Design Assistance

1. Application Hints Rlc Rlc provides the function of feed-forward line compensation to eliminate change in IPP due to change in di/dt and the propagation delay of the internal comparator and MOSFET turn-off time. For best results the chosen value may need to be adjusted based on board, FET and transformer parasitics. Rtl Rtl is added to prevent excessive diode current and limit lopt to the maximum value necessary for regulation. The Rtl value may be adjusted for optimal limiting later during the prototype evaluation process. Rfbt & Rfbb The feedback resistors will set the output voltage of the circuit. The values chosen may need to be fine tuned based on the final Transformer turns ratios and the voltage across the output diode at close to zero current. Rfb3 & Cfb3 Rfb3 is necessary to limit the current into FB and to avoid excess draining of Cvdd during this type of transient situation. The value of Rfb3 is chosen to limit the excess Ifb and Rfb4 current to an acceptable level when the optocoupler is saturated. Cfb3 helps improve the transient response and is estimated initially by equating the time constant to 1ms. This can later be adjusted for optimal performance during prototype evaluation. Rfb4 Rfb4 speeds up the turnoff time of the optocoupler in the case of a heavy load-step transient condition. This value tends to fall within the range of 10k and 100k. A tradeoff must be made between a lower value for faster transient response and a higher value for lower standby power. Rfb4 also serves to set a minimum bias current for the optocoupler and to drain dark current. Part Description The UCC28740 isolated-flyback controller provides Constant-Voltage (CV) using an optical coupler to improve transient response. Constant-Current (CC) regulation is accomplished through Primary Side Regulation (PSR) techniques. Please see the datasheet for further design guidance. <http://www.ti.com/lit/ds/symlink/ucc28740.pdf>

2. Master key : 7298153106F5C5CB[v1]

3. **UCC28740** Product Folder : <http://www.ti.com/product/UCC28740> : contains the data sheet and other resources.

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